October 2008



FGA30N60LSD

General Description

The FGA30N60LSD is a MOS gated high voltage switching device combining the best features of MOSFETs and bipolar transistors. This device has the high input impedance of a MOSFET and the low on-state conduction loss of a bipolar transistor.

Features

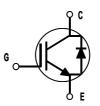
- Low saturation voltage: $V_{CE(sat)} = 1.1V @ I_C = 30A$
- · High Input Impedance
- Low Conduction Loss

Applications

- Solar Inverters
- UPS, Welder







Absolute Maximum Ratings

	Symbol	Description		FGA30N60LSD	Units
	V _{CES}	Collector-Emitter Voltage		600	V
	V _{GES}	Gate-Emitter Voltage		± 20	V
	I _C	Collector Current	@ T _C = 25°C	60	Α
		Collector Current	@ T _C = 100°C	30	Α
www.Da	ata SPM 61)4U.com	Pulsed Collector Current		90	Α
	I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave		150	Α
	P _D	Maximum Power Dissipation	@ T _C = 25°C	480	W
		Maximum Power Dissipation	@ T _C = 100°C	192	W
	T _J	Operating Junction Temperature		-55 to +150	°C
	T _{stg}	Storage Temperature Range		-55 to +150	°C
	T _L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction-to-Case		0.26	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction-to-Case		0.92	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W

Package Marking and Ordering Information

			Packaging		Max Qty	
Device Marking	Device	Package	Туре	Qty per Tube	per Box	
FGA30N60LSD	FGA30N60LSDTU	TO-3PN	Tube	30ea	-	

Electrical Characteristics of the IGBT $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit	
Off Charac	eteristics						
BV _{CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 250uA	600			V	
$\Delta B_{VCES}/$ ΔT_J	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250uA$		0.6		V/°C	
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA	
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			±250	nA	
On Charac	racteristics						
V _{GE(th)}	G-E Threshold Voltage	I _C = 250uA, V _{CE} = V _{GE}	4.0	5.5	7.0	V	
		$I_C = 30A, V_{GE} = 15V$		1.1	1.4	V	
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 30A, V _{GE} = 15V, T _C = 125°C		1.0		V	
		I _C = 60 A, V _{GE} = 15V		1.3		V	
Dynamic Characteristics							
C _{ies}	Input Capacitance			3550		pF	
C _{oes}	Output Capacitance	$V_{CE} = 30V, V_{GE} = 0V,$		245		pF	
C _{res}	Reverse Transfer Capacitance	f = 1MHz		90		pF	
Switching Characteristics							
t _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, I_C = 30\text{A},$ $R_G = 6.8\Omega, V_{GE} = 15\text{V},$ Inductive Load, $T_C = 25^{\circ}\text{C}$		18		ns	
t _r 3Sheet4U.cc	Rise Time			46		ns	
t _{d(off)}	Turn-Off Delay Time			250		ns	
t _f	Fall Time			1.3	2.0	us	
E _{on}	Turn-On Switching Loss			1.1		mJ	
E _{off}	Turn-Off Switching Loss			21		mJ	
t _{d(on)}	Turn-On Delay Time			17		ns	
t _r	Rise Time			45		ns	
t _{d(off)}	Turn-Off Delay Time	V_{CC} = 400 V, I_{C} = 30A, R_{G} =6.8 Ω , V_{GE} = 15V, Inductive Load, T_{C} = 125°C		270		ns	
t _f	Fall Time			2.6		us	
E _{on}	Turn-On Switching Loss			1.1		m.	
E _{off}	Turn-Off Switching Loss			36		m	
Q_g	Total Gate Charge	V _{CE} = 300 V, I _C = 30A, V _{GE} = 15V		225		nC	
Q _{ge}	Gate-Emitter Charge			30		nC	
Q _{gc}	Gate-Collector Charge	7 VGE - 10 V		105		nC	
L _e	Internal Emitter Inductance	Measured 5mm from PKG		7		nH	

Electrical Characteristics of the Diode $T_C = 25^{\circ}C$ unless otherwise noted

Parameter	Conditions			Тур.	Max	Units
V _{FM}	I _F = 15A	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 125 ^{\circ}\text{C}$	-	1.8	2.2	V
	I _F = 15A	T _C = 125 °C	-	1.6	-	V
I _{RM}	V _R = 600V	$T_C = 25 ^{\circ}C$	-	-	100	μΑ
t _{rr}	$I_F = 1A$, di/dt = 100A/ μ s, $V_{CC} = 30V$	T _C = 25 °C	-	-	35	ns
	$I_F = 15A$, di/dt = $100A/\mu s$, $V_{CC} = 390V$	$T_C = 25 ^{\circ}C$	-	-	40	ns
t _a	$I_F = 15A$, di/dt = $100A/\mu s$, $V_{CC} = 390V$	T _C = 25 °C	-	18	-	ns
t_b		T _C = 25 °C	-	13	-	ns
Q _{rr}		T _C = 25 °C	-	27.5	-	nC

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Typical Performance Characteristics

Figure 1.Typical Output Characteristics

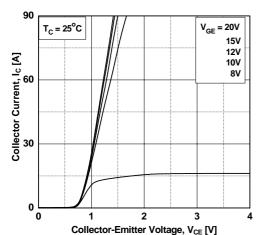


Figure 3. Typical Saturation Voltage Characteritics

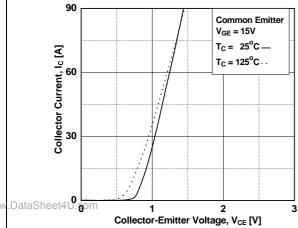


Figure 5. Saturation Voltage vs. Case
Temperature at Variant Current Level

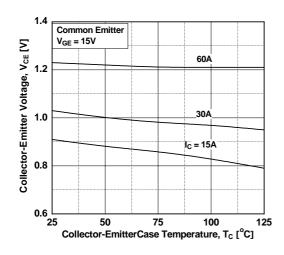


Figure 2. Typical Saturation Voltage Characteristics

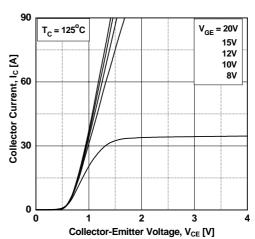


Figure 4. Transfer characteristics

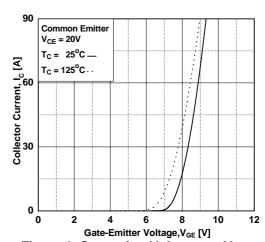
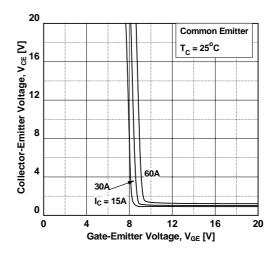


Figure 6. Saturation Voltage vs. Vge



Typical Performance Characteristics (Continued)

Figure 7. Saturation Voltage vs. Vge

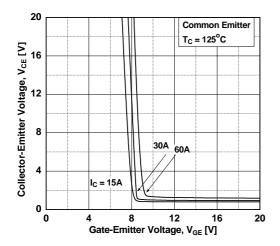


Figure 9. Gate Charge Characteristics

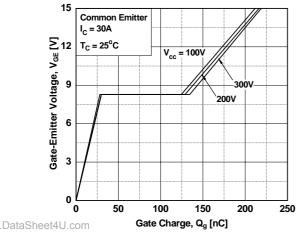


Figure 11. Load Current Vs. Frequency

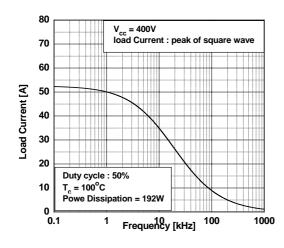


Figure 8. Capacitance characteristics

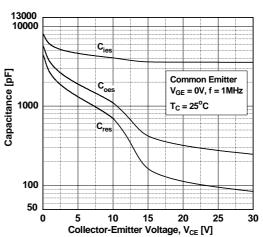


Figure 10. SOA Characteeristics

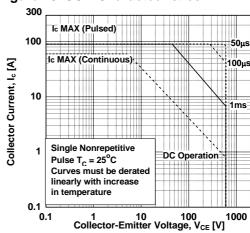
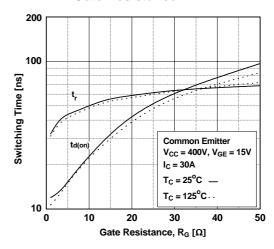


Figure 12. Turn-On Characteristics vs.
Gate Resistance



Typical Performance Characteristics (Continued)

Figure 13. Turn-Off Characteristics vs.
Gate Resistance

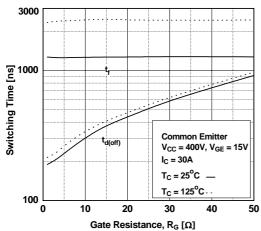


Figure 15. Turn-Off Characteristics vs. Collector Current

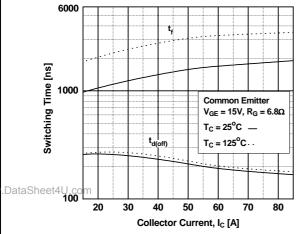


Figure 17.Switching Loss vs Collector Current

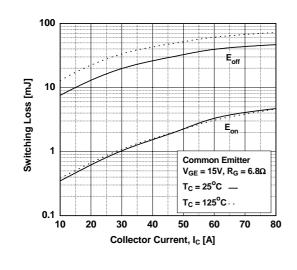


Figure 14. Turn-On Characteristics vs. Collector Current

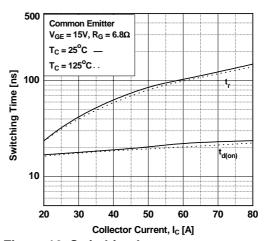


Figure 16. Switching Loss vs Gate Resistance

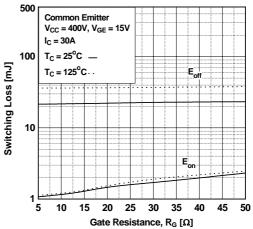
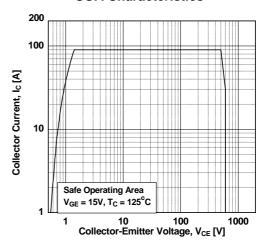


Figure 18. Turn-Off Switching SOA Characteristics





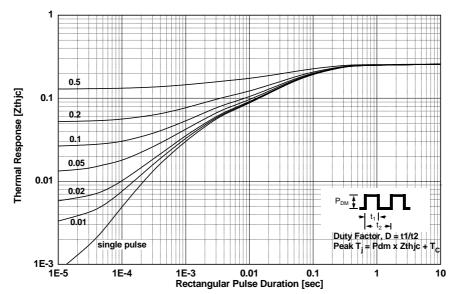
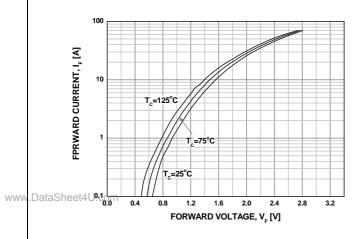


Figure 20. Typical Forward Voltage Drop

Figure 21. Typical Reverse Current



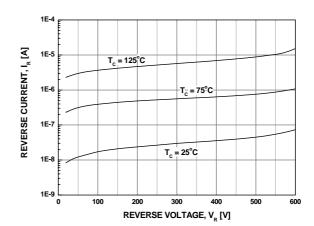
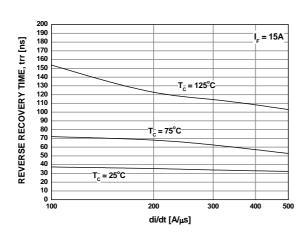
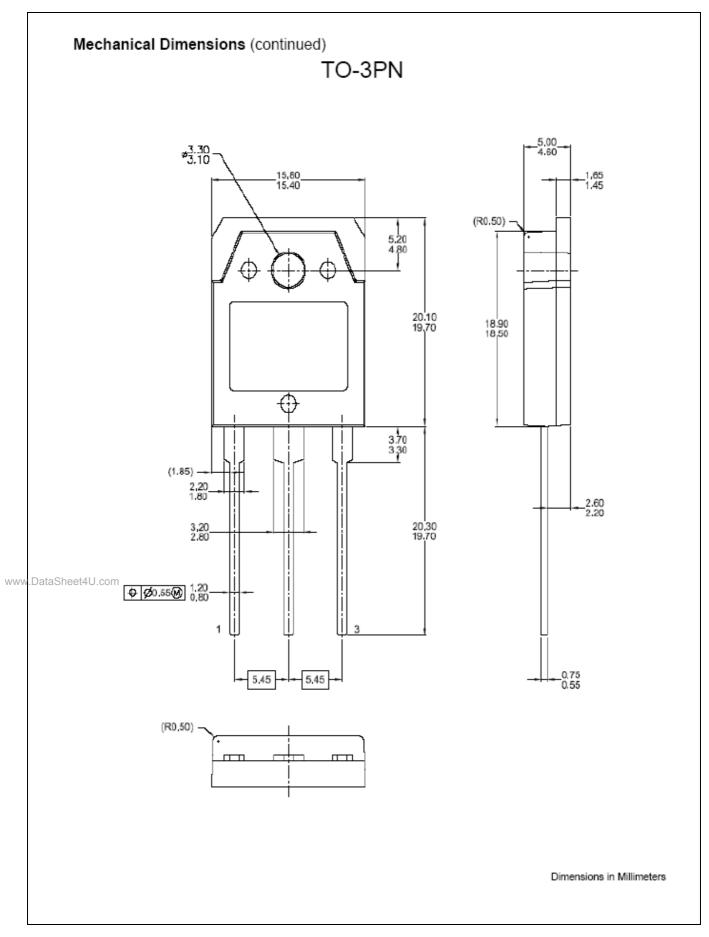


Figure 22. Typical Reverse Recovery Time









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